

IBM Docket No: FIS920000379US1

Declaration and Power of Attorney for Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name; I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled:

METHOD OF ETCHING HIGH ASPECT RATIO OPENINGS

the specification of which (check one)



is attached hereto.



was filed on _____ as Application Serial No. _____ and was amended on _____.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability as defined in 37 CFR §1.56.

I hereby claim foreign priority benefits under 35 USC §119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate, or §365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s):

Number	Country	Day/Month/Year	Priority Claimed
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I hereby claim the benefit under 35 USC §119(e) of any United States provisional application(s) listed below:

Application Number	Filing Date
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I hereby claim the benefit under 35 USC §120 of any United States application(s), or §365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 USC §112, I acknowledge the duty to disclose information material to the patentability of this application as defined in 37 CFR §1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application:

Prior U.S. Applications:

T05090" 60742360

Serial No.	Filing Date	Status (patented, pending, abandoned)
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I hereby appoint the following attorneys and/or agents to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: Anthony P. DeLio (Reg. No. 18,729); Peter W. Peterson (Reg. No. 31,867); John J. Tomaszewski (Reg. No. 26,241); Robert Curcio (Reg. No. 44, 638); Kelly M. Reynolds (47,898); Joseph P. Abate (Reg. No. 30,238); Jay H. Anderson (Reg. No. 38,371); Ira D. Blecker (Reg. No. 29,894); Steven Capella (Reg. No. 33,086); Dale M. Crockatt (Reg. No. 35,109); Harold Huberfield (Reg. No. 26,665); Todd M.C. Li (Reg. No. 45,554); Susan Murray (Reg. No. 38,252); Daryl K. Neff (Reg. No. 38,253); Margaret A. Pepper (Reg. No. 45,008); Eric W. Petraske (Reg. No. 28,459); Marc D. Schechter (Reg. No. 28,989); H. Daniel Schnurmann (Reg. No. 35,791); William P. Skladony (Reg. No. 33,787); Tiffany L. Townsend (Reg. No. 43,199).

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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T05090 60742860

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

APPLICANT:: Gangadhara S. Mathad et al.

SERIAL NO.:

FILING DATE:

FOR: METHOD OF ETCHING HIGH ASPECT RATIO
OPENINGS**ASSOCIATE POWER OF ATTORNEY**Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

INTERNATIONAL BUSINESS MACHINES CORPORATION, owner of the above identified patent application, hereby appoints Christopher A. Hughes, Reg. No. 26,914; Edward A. Pennington, Reg. No. 32,588; John E. Hoel, Reg. No. 26,279; and Joseph C. Redmond, Jr., Reg. No. 18,753; all of Morgan & Finnegan, as its associate attorneys to prosecute said patent application, to make alterations and amendments therein, to take any and all other actions with regard to this patent application and the resulting patent and to transact all business with the Patent and Trademark Office connected therewith.

Please continue to address all future correspondence to:

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Respectfully submitted,

By: Susan Murray

Susan Murray

Reg. No. 38,252

CERTIFICATION OF MAILING UNDER 37 CFR 1.10

"Express Mail" mailing label number EF8836-96-10 Date of Deposit: 1/1/92 I hereby certify that this paper or fee is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231

Name: K. C. A. G. - MRS.
lbmf100329000assocpwrSignature: [Signature]